



Docket No.:

DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint

inventor (1	of plural name	s are listed below) of the	he subject matter which is claim	med and for which a patent is sought on th
		ANAERO	DBIC ADHESIVE COMPOSIT	rion
the specifica	ition of which:			
[] is attacl (if applicabl		[]was filed on	as Application Serial No.	and was amended on
		reviewed and understan nt referred to above.	d the contents of the above ide	entified specification, including the claims, a
ूरिode of Fed	eral Regulation	ns. § 1.56*		of this application in accordance with Title 3
口 hereby cla Cinventor's co Ca filing date 石	im foreign pri crtificate listed before that of	iority benefits under Titl below and have also ide the application on which	te 35, United States Code, § 1 ntified below any foreign application priority is claimed:	19 of any foreign application(s) for patent or ation for patent or inventor's certificate having
UPrior Forcis	go Application	n(s)	priority cla	imed
Number	Country	Dav/Month/Year Filed	<u>yes</u>	no
90-3323	KR	05/02/1998		x
口 hereby clai	m the benefit i	mder Title 35. United St	ates Code, § 120 of any United	States application(s) listed below
TPrior Provis	sional Applica	tion(s)		
Application	Number	Filing Da	<u>ite</u>	
I hereby clai any PCT into this applicati paragraph of 37 Code of	emational applion is not disc Title 35, Unite Federal Regula	lication designating the U losed in the prior United ad States Code, section 1	Jnite State, listed below insofar I States or PCT international ap 12, I acknowledge the duty to di	ed States application(s)—or Section 365(c) of as the subject matter of each of the claims of oplication in the manner provided by the first sclose material information as defined in Title ate of the prior application and the national or
Prior Provis	ional Applica	tion(s)		
Application		Filing Da	te Status: Patented	, Pending, Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statement and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.





I hereby appoint the following attorney(s) and or/agent(s): Allan M. Low, Reg. No. 19.641; Benjamin, Reg. No. 29.310; Israel Gopstein, Reg. No. 27.333; Kenneth M. Berner, Reg. No. 37.093; Micheal G. Gilman, Reg. No. 19.114; Albert J. Fasulo II. Reg. No. 43.607; and Randy Noranbrock, Reg. No. 42.940, all of

LOWE HAUPTMAN GOPSTEIN GILMAN & BERNER LLP 1700 Diagnol Road, Suite 310 Alexandria, Virginia 22314

with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them. Y | Full Name of Sole or the First Inventor PARK, In Hwan On b. part Date March Inventor's Signature Residence 101-102 Hyundae Apt., 431-6, Doryong-dong, Yusung-ku, Daejeon 305-340, Republic of Korea KRX Citizenship Republic of Korea Full stame of Sole or the Second Joint Inventor _____ CHE, Sang Chui Date March 7, 2002 Inventor's Signature Residence 502-803 Kookhwa Apt., 991, Samcheon-dong, Sco-ku, Daejeon 302-222, Republic of Korea Citizenship Republic of Korea Full Name of Sole or the Third Joint Inventor_____ _____Date_____ ■ Residence Post Office Address ***************** ull Name of Sole or the Fourth Joint Inventor _____ Date____ Tinventor's Signature _____ Residence _ Citizenship _ ************************* Full Name of Sole or the Fifth Joint Inventor_____ Inventor's Signature ____Date Residence Citizenship | Post Office Address